

IR-1837 (2-2841)



THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Patent Application of

Mark PAVIER

Serial No.: 10/050,002

Group Art Unit: 2815

Filed: January 15, 2002

Examiner: C. Chu

For: BACK-TO-BACK CONNECTED POWER SEMICONDUCTOR DEVICE PACKAGE

Mail Stop RCE  
Commissioner for Patents  
P.O. Box 1450  
Alexandria, VA 22313-1450

RECEIVED  
JAN - 6 2004  
TECHNOLOGY CENTER 2000

EXAMINER INTERVIEW SUMMARY RECORD

Sir:

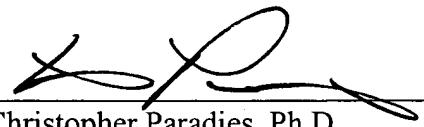
The Applicant's representative, the Examiner and the primary supervisor of the Examiner held a telephonic interview to discuss the objections to the figures and the rejection of claims 12-17 and 18. The Examiner and the primary supervisor agreed that the arguments and amendments overcome all of the objections and rejections; however, further search and consideration are necessary. The amendments to the claims were not entered.

Specifically, amended Figures 1 and 2 show all of the elements of the claims, as amended, in sufficient detail.

Also, the amendment to claim 12 and the arguments made traverse the rejection of claims 12-17 based on the Kim reference. The Examiner acknowledges that the structure of the conductive die pad is different than the interface board disclosed in the Kim reference.

In addition, the amendment to claim 18 traverses the rejection of claim 18.

Dated: December 23, 2003

  
Christopher Paradies, Ph.D.  
Attorney of Record for Applicants